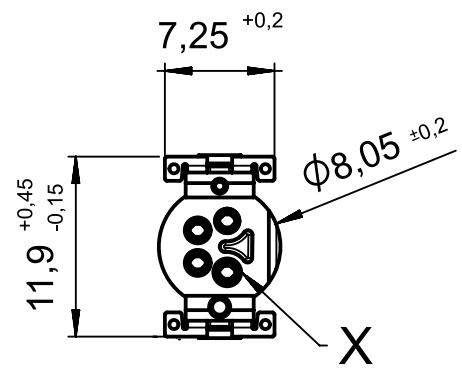
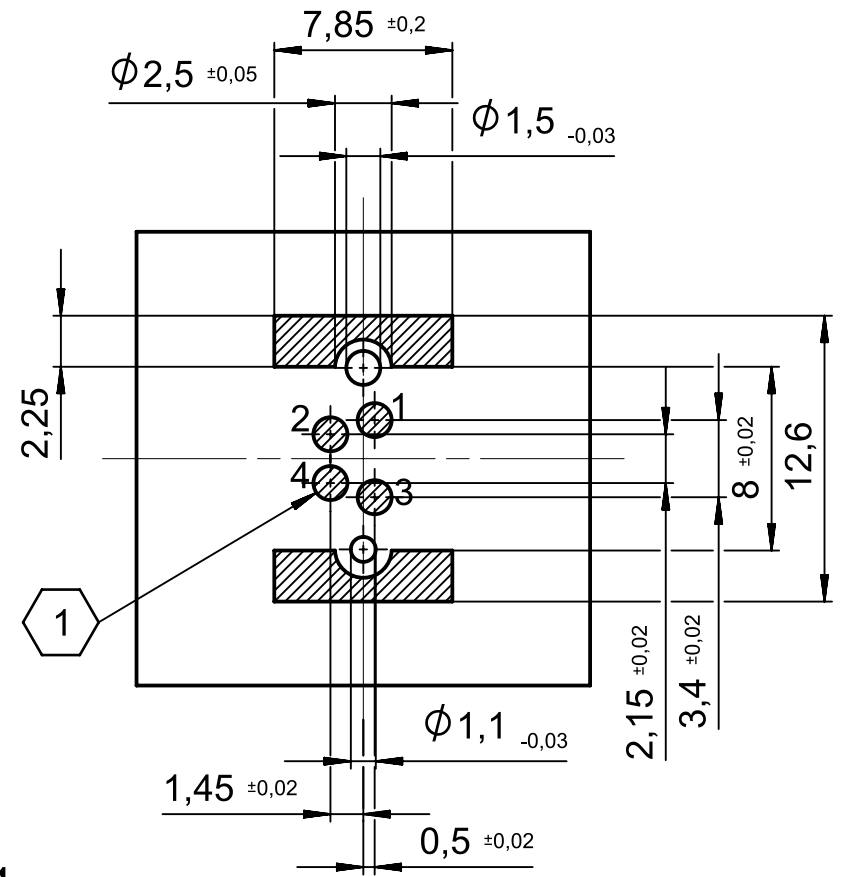


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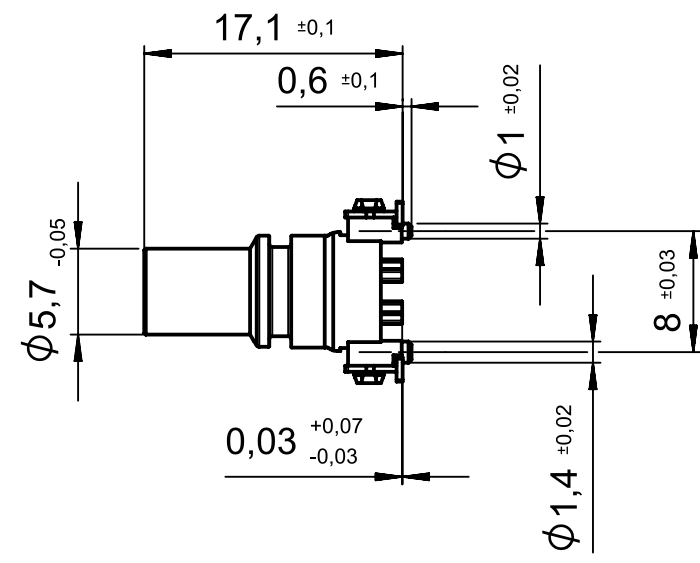
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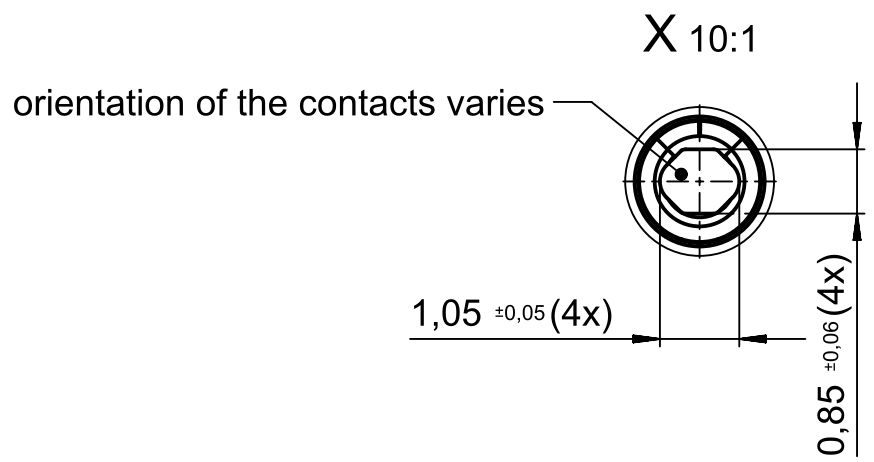
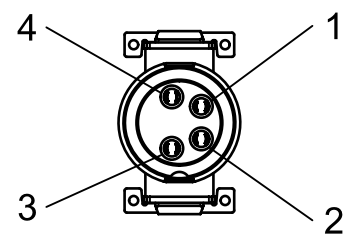
PCB-layout
(advice)



3:1



socket face female



orientation of the contacts varies

Coplanarity of all contacts and anchor plate  0.1

Recommended solder paste thickness 150µm

1 Further information on soldering process and recommended layout, see brochure "Connectors for SMT production"

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